

Description

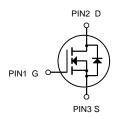
The IRLML6244PBF uses advanced trench technology to provide excellent $R_{DS(ON)}$,low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

D S G

SOT-23

General Features

 $V_{DS} = 20V, I_D = 7A$ $R_{DS(ON)} < 17m\Omega$ @ $V_{GS} = 4.5V$ $R_{DS(ON)} < 25m\Omega$ @ $V_{GS} = 2.5V$



N-Channel MOSFET

Application

High power and current handing capability
Lead free product is acquired
Surface mount package
PWM applications

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
IRLML6244PBF	SOT-23	HXY MOSFET	3000

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage	20	V
V _G S	Gate-Source Voltage	±12	V
I _D	Drain Current-Continuous	7	Α
Ідм	Drain Current-Pulsed (Note 1)	32	А
P _D	Maximum Power Dissipation	2	W
T _J ,T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\!\mathbb{C}$
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	120	°C/W



Electrical Characteristics (TJ=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	20	-	_	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±12V	-	-	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.75	1.2	V
D	Static Drain-Source on-Resistance	V _{GS} =4.5V, I _D =7A	-	15	17	-m0
$R_{DS(on)}$	note2	V _{GS} =2.5V, I _D =5A	-	19	25	mΩ
C _{iss}	Input Capacitance	14 4014 14 014	-	700	_	pF
Coss	Output Capacitance	V _{DS} =10V, V _{GS} =0V, f=1.0MHz	-	132	-	pF
C _{rss}	Reverse Transfer Capacitance	1-1.0WIFIZ	-	114	-	pF
Qg	Total Gate Charge	1011111	-	15	-	nC
Q _{gs}	Gate-Source Charge	V _{DS} =10V, I _D =4A, V _{GS} =4.5V	-	2	-	nC
Q _{gd}	Gate-Drain("Miller") Charge	VGS-4.5V	-	5.2	-	nC
t _{d(on)}	Turn-on Delay Time) / 40) /	-	9	_	ns
t _r	Turn-on Rise Time	V _{DS} =10V,	-	25	-	ns
t _{d(off)}	Turn-off Delay Time	I_D =4A, R_{GEN} =3 Ω , V_{GS} =4.5 V	-	37	-	ns
t _f	Turn-off Fall Time	VGS-4.5V	-	14	-	ns
ı	Maximum Continuous Drain to Source Diode Forward				7.5	^
Is	Current		-	-	7.5	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	32	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =8A	-	-	1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

^{2.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

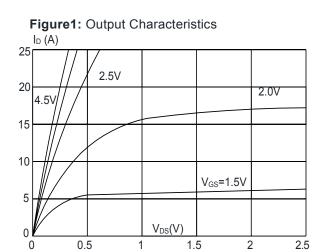


Figure 2: Typical Transfer Characteristics

25

20

15

10

5

125°C

25°C

0

0

0

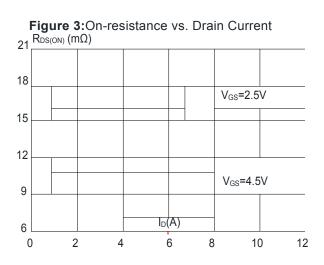
0

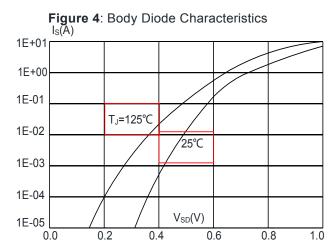
1.5

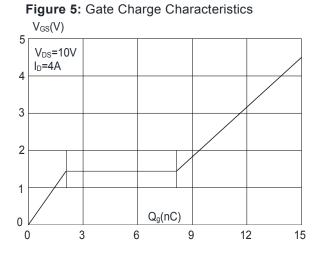
2.0

2.5

3.0







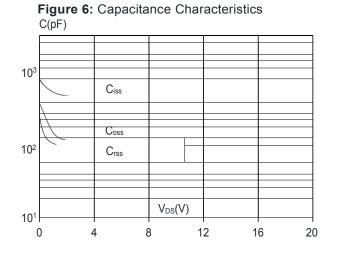




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

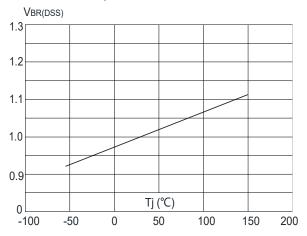


Figure 9: Maximum Safe Operating Area

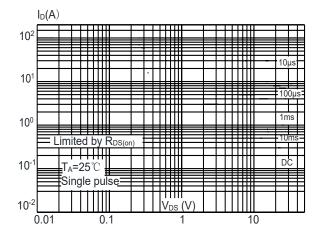


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

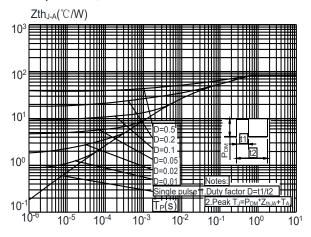


Figure 8: Normalized on Resistance vs. Junction Temperature

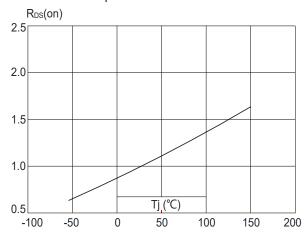
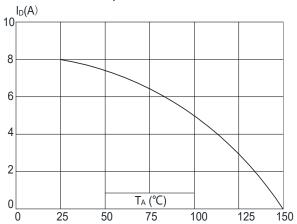
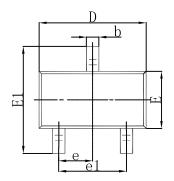


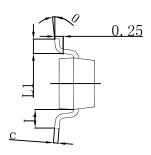
Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature

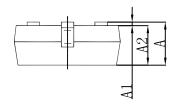




SOT-23 Package Outline Dimensions

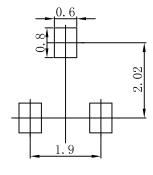






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
Е	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
 3.The pad layout is for reference purposes only.



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